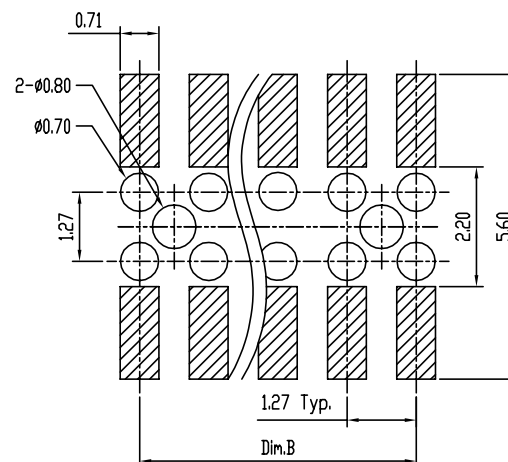
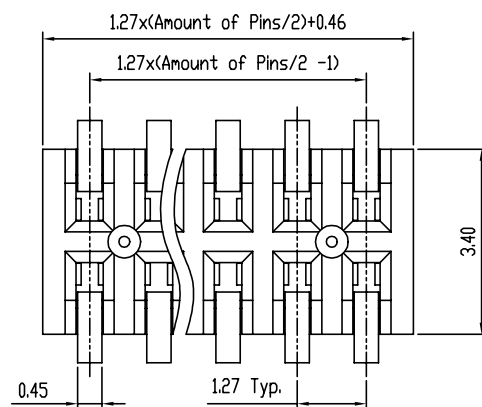
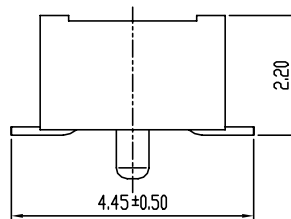
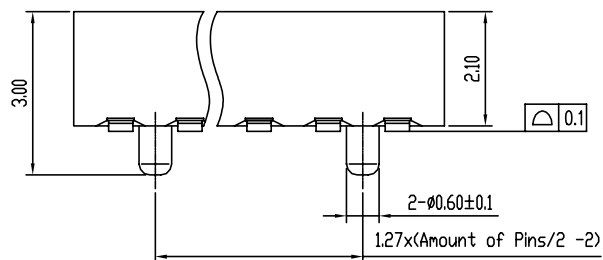
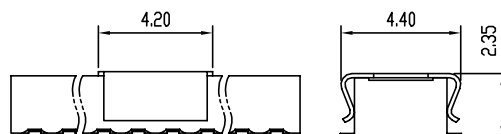




Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm



With Cap
Scale 4:1

NOTE:

1. MATERIAL:
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, $T=0.15$ MM
CAP: STAINLESS STEEL, $T=0.1$ MM
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER $1.27\mu\text{m}(50\text{u})$ MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260°C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION INFRA-RED
OR VAPOR PHASE REFLOW.
5. PRODUCT NUMBERING:
20021323 - X 0 0 XX X X LF

LEAD FREE

PLATING:

1: GOLD FLASH ALL OVER
4: $0.25\mu\text{m}(10\text{U})$ GOLD AT CONTACT
8: $0.76\mu\text{m}(30\text{U})$ GOLD AT CONTACT
9: 1u GOLD OVER 30u PdNi AT CONTACT

PACKING

D: TUBE + CAP

T: TUBE

C: REEL + CAP (8, 10, 20, 22, 30, 40, 42, 70P)

PIN COUNT

4, 6, 8, ..., 80

(EVERY EVEN PIN)

0: WITHOUT POST

1: WITH POST

mat'l. code				surface		tolerance		projection		product family						
				ISO1302 ✓		ISO1101 ISO406				MINITEK						
ltr		ecn		nodr		date		tolerances unless otherwise specified		title						
A	T09-1117		S.LIN		09/15/09		angle		0.X±0.38				1.27X1.27MM BTB RECEPTACLE SMT BOTTOM ENTRYR			
B	T10-0020		S.LIN		01/20/10		line at		0.XX±0.25							
C	T10-0120		S.LIN		07/30/10		0°±2'		0.XXX±0.10							
								scale 8:1								
D	ELX004402		S.LIN		07/11/11		dr		STERLING LIN		09/15/09				dwg no sheet 1 of 1 size	
E	BX-N-010370		ZK		01/16/12		engr		STERLING LIN		09/15/09					
F	BX-N-011532		ZK		05/07/12		chr		GRAY HSIEH		09/15/09					
G	BX-N-011756		ZK		05/28/12		appd		JOSEPH		09/15/09					
sheet		revising														
index		sheet		1												